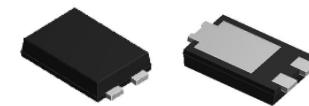
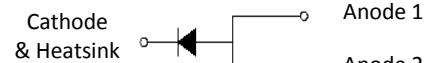


Features

- Schottky barrier diodes
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Low profile - typical height of 1.1 mm
- Heatsink design
- High temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition


eSGC


TYPICAL APPLICATIONS

For low voltage high frequency inverters, DC/DC converters and polarity protection application.

MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	SGC1560S		UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	60		V
Maximum RMS voltage	V _{RMS}	42		V
Maximum DC blocking voltage	V _{DC}	60		V
Maximum average forward rectified current	I _{F(AV)}	15.0		A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	300		A
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150		°C

ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	I _F =1A	T _A =25°C	0.29	0.32	Volts
	I _F =2A		0.32	0.35	
	I _F =15A		0.48	0.55	
	I _F =1A	T _A =85°C	0.22	0.27	
	I _F =2A		0.25	0.30	
	I _F =15A		0.46	0.50	
	I _F =1A	T _A =125°C	0.18	0.23	
	I _F =2A		0.22	0.27	
	I _F =15A		0.45	0.48	
Maximum DC reverse current at rated DC blocking voltage	Rated VR	T _A =25	0.06	0.2	mA
		T _A =85	2.5	10	
		T _A =125	20	50	
Typical junction capacitance	4.0 V, 1 MHz	C _J	0.95		nF
Typical thermal resistance	junction to lead	R _{θJL}	3		°C/W

RATINGS AND CHARACTERISTICS CURVES

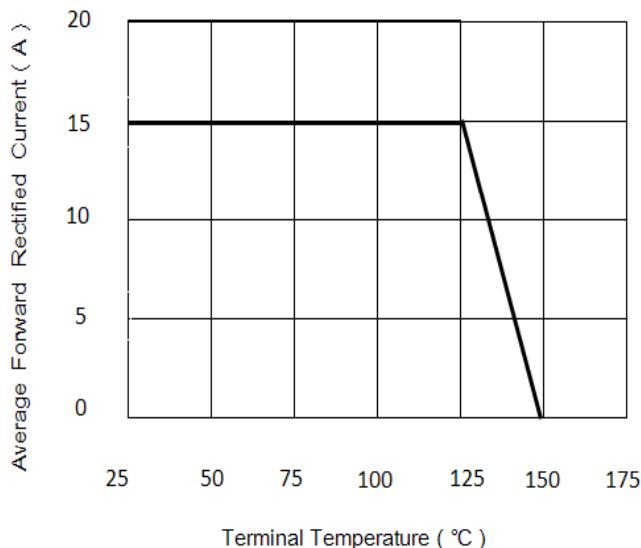


Figure 1. Forward Current Derating Curve

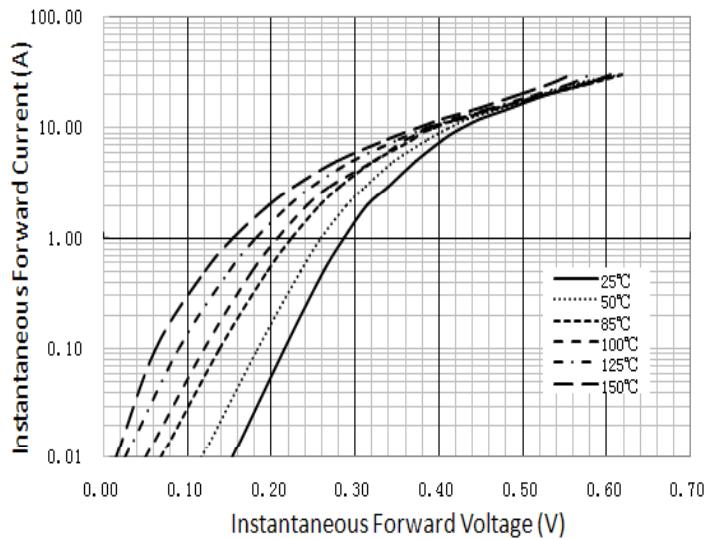


Figure 2. Typical Instantaneous Forward Characteristics

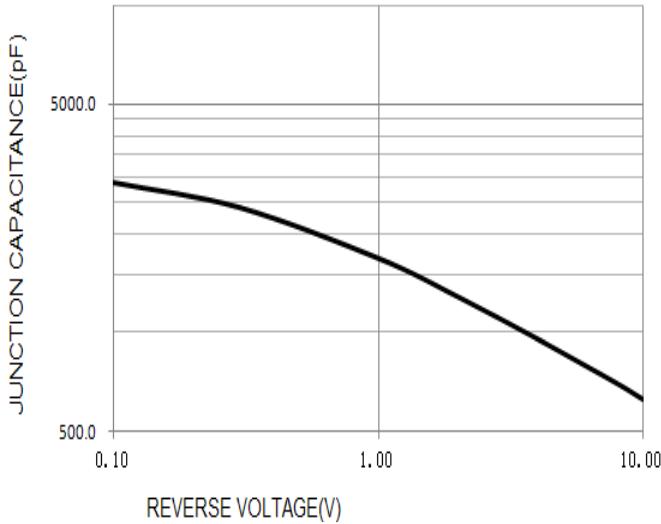


Figure 3. Typical Junction Capacitance

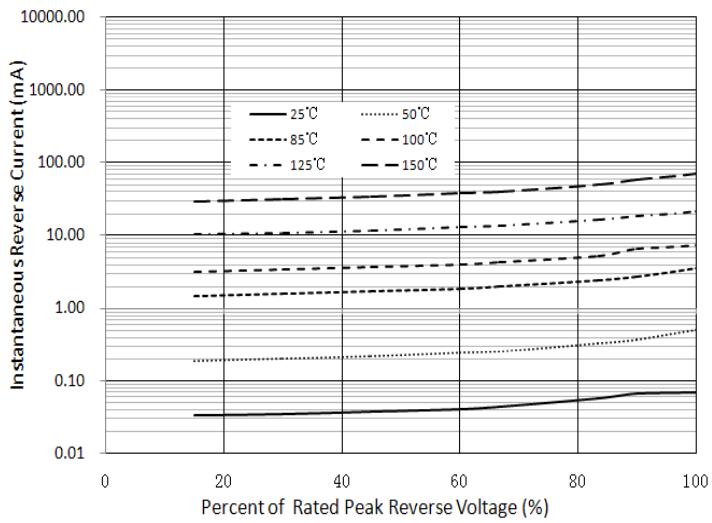


Figure 4. Typical Reverse Characteristics

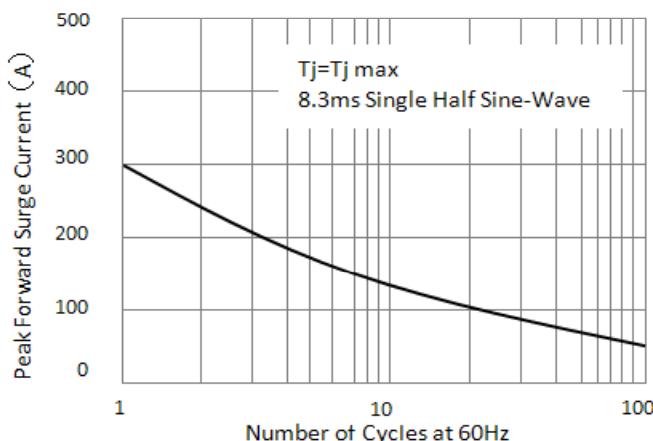
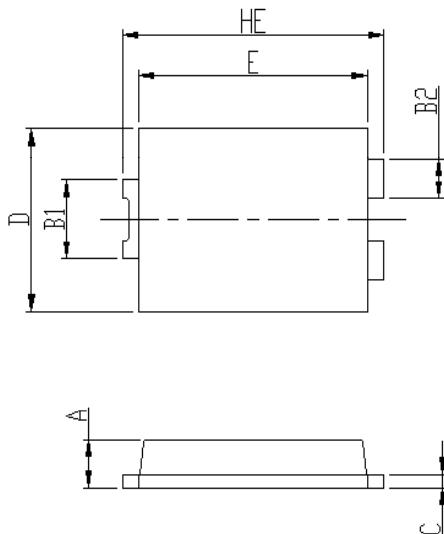
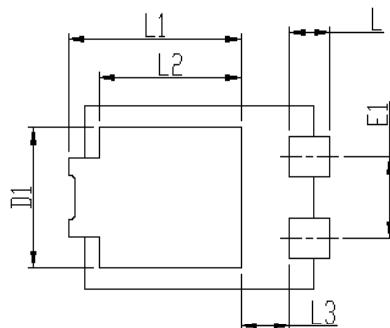


Figure 5. Maximum Non-Repetitive Peak Forward Surge Current

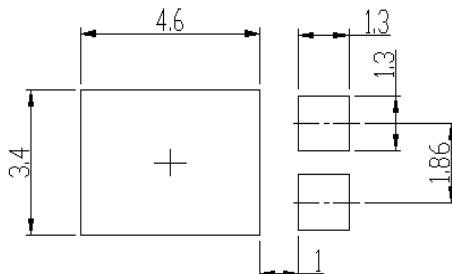
PACKAGE OUTLINE DIMENSIONS



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.1	4.3	0.161	0.169
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52	Typ.	0.139	Typ.
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86	Typ.	0.073	Typ.



Soldering footprint



PACKING INFORMATION

Packing quantities:

5000 pcs/Reel , 12mm Tape, 13" Reel

Tape & Reel Specification

